

SURFACE-PROTECTING ADHESIVE TAPE FOR PROCESSING
SEMICONDUCTORS

ABSTRACT

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A surface-protecting adhesive tape for processing semiconductors, having an adhesive layer provided on a base material, wherein a probe tack force B of the adhesive tape is 0.08 to 0.20 (MPa), and a ratio C (A/B) of an adhesive force A (N/25mm) to the probe tack force B (MPa) of the adhesive tape

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is not less than 10 (N/25mm/MPa).